


# PRODUCT / PROCESS CHANGE NOTIFICATION

## 1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	ADG/16/9979	
1.3 Title of PCN	VIPower M02: AMK6 Second Source Activation beside CT6 for additional products	
1.4 Product Category	see list	
1.5 Issue date	2016-11-29	

## 2. PCN Team

2.1 Contact supplier	
2.1.1 Name	FRANK WOLINSKI
2.1.2 Phone	+49 89460062287
2.1.3 Email	frank.wolinski@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Roberto CRISAFULLI
2.1.2 Marketing Manager	Nicola LIPORACE
2.1.3 Quality Manager	Francesco MINERVA

## 3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer of a full process or process brick (process step, control plan, recipes) from one site to another site	Wafer fabrication site	ST AMK6 (AngMoKio - Singapore)

## 4. Description of change

	Old	New
4.1 Description	Catania 6" Wafer Fab (CT6)	Catania 6" Wafer Fab (CT6) and Singapore 6" Wafer Fab (AMK6)
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact	

## 5. Reason / motivation for change

5.1 Motivation	Complete M02 products transfer from CT6 to AMK6, reaching 100% of production flexibility between the 2 Fabs
5.2 Customer Benefit	DOUBLE SOURCING

## 6. Marking of parts / traceability of change

6.1 Description	Dedicated Finished Good Codes
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## 7. Timing / schedule

7.1 Date of qualification results	2016-10-28
7.2 Intended start of delivery	2017-04-30
7.3 Qualification sample available?	Upon Request

## 8. Qualification / Validation

8.1 Description	RR000816CT2235_1 0_VNK3_VN19_VN49_M02_AMK6 second source.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2016-11-29

## 9. Attachments (additional documentations)

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	VND5N07-E	
	VNP10N07-E	
	VNP35N07-E	
	VNP5N07-E	
	VNP7N04-E	

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